

STGW35HF60WD

35 A, 600 V ultra fast IGBT

Features

- Improved E_{off} at elevated temperature
- Minimal tail current
- Low conduction losses
- V_{CE(sat)} classified for easy parallel connection
- Ultra fast soft recovery antiparallel diode

Applications

- Welding
- High frequency converters
- Power factor correction



The STGW35HF60WD is based on a new advanced planar technology concept to yield an IGBT with more stable switching performance (E_{off}) versus temperature, as well as lower conduction losses. The device is tailored to high switching frequency operation (over 100 kHz).

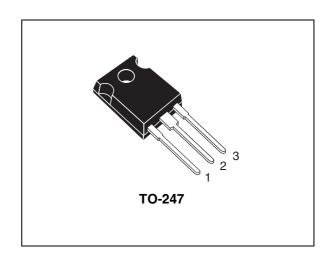


Figure 1. Internal schematic diagram

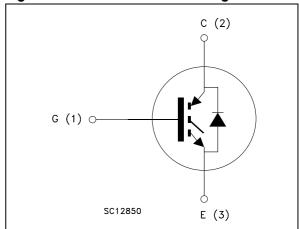


Table 1. Device summary

Order code	Marking ⁽¹⁾	Package	Packaging
	GW35HF60WDA		
STGW35HF60WD	GW35HF60WDB	TO-247	Tube
	GW35HF60WDC		

Collector-emitter saturation voltage is classified in group A, B and C, see Table 5: VCE(sat) classification. STMicroelectronics reserves the right to ship from any group according to production availability.

Electrical ratings STGW35HF60WD

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Continuous collector current at T _C = 25 °C	60	Α
I _C ⁽¹⁾	Continuous collector current at T _C = 100 °C	35	Α
I _{CP} ⁽²⁾	Pulsed collector current	150	Α
I _{CL} (3)	Turn-off latching current	80	Α
V_{GE}	Gate-emitter voltage	± 20	٧
I _F	Diode RMS forward current at T _C = 25 °C	30	Α
I _{FSM}	Surge non repetitive forward current t _p = 10 ms sinusoidal	120	Α
P _{TOT}	Total dissipation at T _C = 25 °C	200	W
T _{stg}	Storage temperature	- 55 to 150	
Tj	Operating junction temperature	- 55 10 150	°C

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Pulse width limited by maximum junction temperature and turn-off within RBSOA
- 3. V_{CLAMP} = 80% (V_{CES}), V_{GE} = 15 V, R_{G} = 10 Ω , T_{J} = 150 °C

Table 3. Thermal data

Symbol	Parameter	Value	Unit
В	Thermal resistance junction-case IGBT	0.63	°C/W
R _{thj-case}	Thermal resistance junction-case diode	1.5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W

2 Electrical characteristics

 $(T_J = 25 \, ^{\circ}C \text{ unless otherwise specified})$

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			V
V	Collector-emitter	V _{GE} = 15 V, I _C = 20 A			2.5	V
V _{CE(sat)}	saturation voltage	$V_{GE} = 15V$, $I_{C} = 20$ A, $T_{J} = 125$ °C		1.65		v
$V_{GE(th)}$	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 1 \text{ mA}$	3.75		5.75	V
I _{CES}	Collector cut-off current	V _{CE} = 600 V			250	μΑ
ICES	$(V_{GE} = 0)$	$V_{CE} = 600 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			1	mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20 V			± 100	nA

Table 5. V_{CE(sat)} classification

Symbol	Parameter	Group	Value		Unit
Cymbol	i arameter	Стопр	Min.	Max.	Oilit
		Α	1.68	1.92	
V _{CE(sat)}	$V_{CE(sat)}$ Collector-emitter saturation voltage $V_{GE} = 15 \text{ V}, I_{C} = 20 \text{ A}$	В	1.88	2.17	V
	- GE = .3 ·, .C= 23 / .	С	2.13	2.50	

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0	-	2400 235 50	-	pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 400 \text{ V}, I_{C} = 20 \text{ A},$ $V_{GE} = 15 \text{ V},$ (see Figure 17)	1	140 13 52	1	nC nC nC

Electrical characteristics STGW35HF60WD

Table 7. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 400 \text{ V}, I_C = 20 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ (see Figure 16)	-	30 15 1650	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 400 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{J} = 125 \text{ °C} \text{ (see Figure 16)}$	-	30 15 1600	-	ns ns A/µs
$t_r(V_{off})$ $t_d(_{off})$ t_f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 400 V, I_{C} = 20 A, R_{GE} = 10 Ω , V_{GE} = 15 V (see Figure 16)	-	30 175 40	-	ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 400 \text{ V}, I_{C} = 20 \text{ A},$ $R_{GE} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{J} = 125 \text{ °C}$ (see Figure 16)	-	50 225 70	-	ns ns ns

Table 8. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} ⁽¹⁾	Turn-on switching losses	$V_{CC} = 400 \text{ V}, I_{C} = 20 \text{ A}$		290		μJ
E _{off}	Turn-off switching losses	$R_G = 10 \Omega, V_{GE} = 15 V,$	-	185		μJ
E _{ts}	Total switching losses	(see Figure 18)		475		μJ
E _{on} ⁽¹⁾	Turn-on switching losses	V _{CC} = 400 V, I _C = 20 A		420		μJ
E _{off}	Turn-off switching losses	$R_G = 10 \Omega, V_{GE} = 15 V,$	-	350	530	μJ
E _{ts}	Total switching losses	T _J = 125 °C (see Figure 18)		770		μJ

Eon is the tun-on losses when a typical diode is used in the test circuit in *Figure 18*. If the IGBT is offered
in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs and diode are at the
same temperature (25 °C and 125 °C). Eon include diode recovery energy.

Table 9. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 20 A I _F = 20 A, T _J = 125 °C	-	1.8 1.4	2.25	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 50 \text{ V},$ di/dt = 100 A/ μ s (see Figure 19)	-	50 90 3	-	ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 50 \text{ V},$ $T_J = 125 ^{\circ}\text{C}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ (see Figure 19)	-	135 375 5.5	-	ns nC A

Electrical characteristics (curves) 2.1

Figure 2. **Output characteristics**

 $I_{C}(A)$ V_{GE}= 15 V 11 V 10 V 150 9 V 100 8 V 50 7 V V_{GE} = 6 V $V_{CE}(V)$

Transfer characteristics Figure 3.

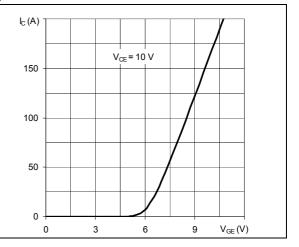
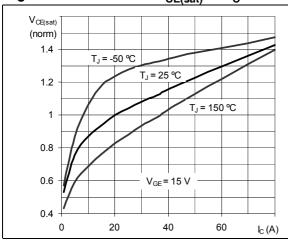


Figure 4. Normalized $V_{CE(sat)}$ vs. I_{C}



Normalized $V_{CE(sat)}$ vs. temperature Figure 5.

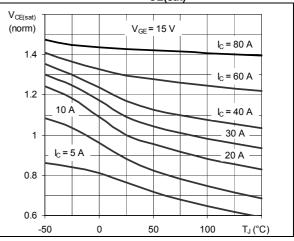
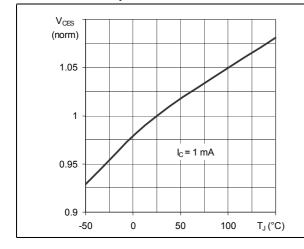
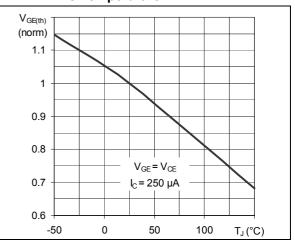


Figure 6. Normalized breakdown voltage vs. Figure 7. temperature

Normalized gate threshold voltage vs. temperature

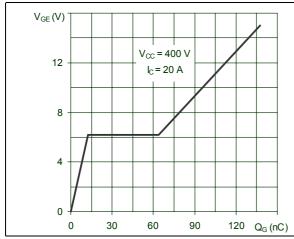




Electrical characteristics STGW35HF60WD

Figure 8. Gate charge vs. gate-emitter voltage

Figure 9. Capacitance variations



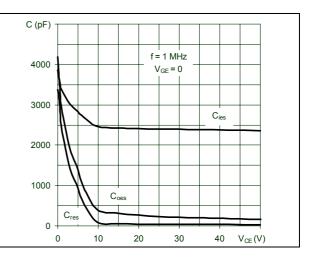
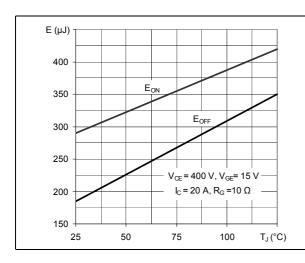


Figure 10. Switching losses vs temperature

Figure 11. Switching losses vs. gate resistance



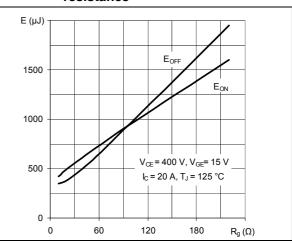
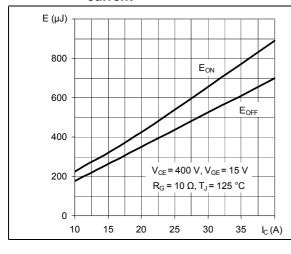


Figure 12. Switching losses vs. collector current

Figure 13. Turn-off SOA



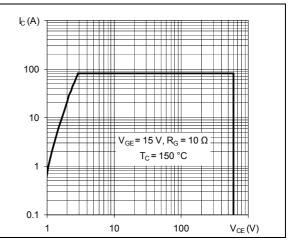
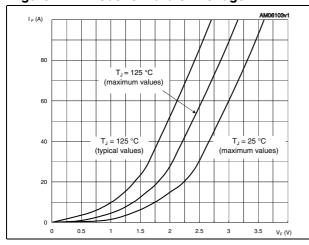
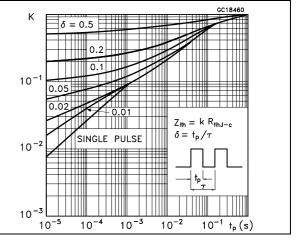


Figure 14. Diode forward on voltage

Figure 15. Thermal impedance





Test circuits STGW35HF60WD

3 Test circuits

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

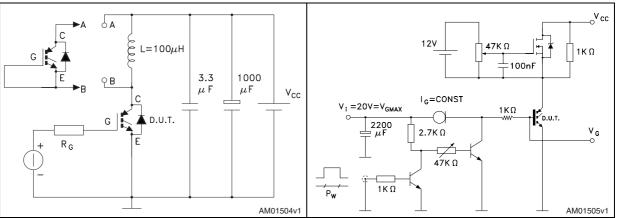
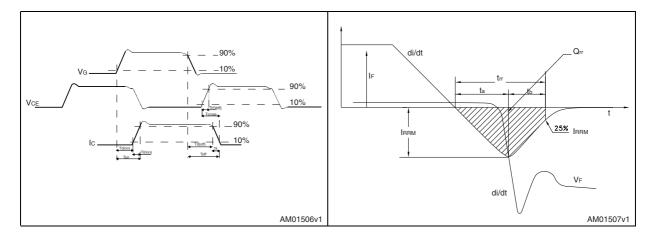


Figure 18. Switching waveform

Figure 19. Diode recovery time waveform



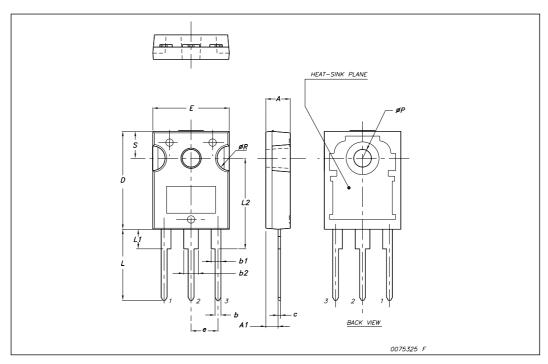
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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

TO-247 Mechanical data

Dim.		mm.	
Dilli.	Min.	Тур	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
øΡ	3.55		3.65
øR	4.50		5.50
S		5.50	



STGW35HF60WD Revision history

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
14-Apr-2009	1	Initial release.
03-Aug-2009	2	Inserted dynamic parameters on <i>Table 6</i> an <i>Table 7</i> Document status promoted from preliminary data to datasheet
02-Sep-2009	3	Minor text changes throughout the document Removed watermark
30-Sep-2009	4	Inserted V _{CE(sat)} grouping A, B and C (see <i>Table 5: VCE(sat)</i> classification)
10-May-2010	5	Inserted Section 2.1: Electrical characteristics (curves)

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